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February 2015

MMBTA28 / PZTA28 NPN Darlington Transistor

Description

This device is designed for applications requiring extremely high current gain at collector currents to 500 mA. Sourced from process 03.

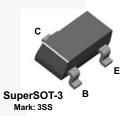


Figure 1. MMBTA28 Device Package

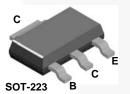


Figure 2. PZTA28 Device Package

Ordering Information

Part Number	Number Top Mark Package		Packing Method	
MMBTA28	3SS	SSOT 3L	Tape and Reel	
PZTA28	A28	SOT-223 4L	Tape and Reel	

Absolute Maximum Ratings(1), (2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	80	V
V _{CBO}	Collector-Base Voltage	80	V
V _{EBO}	Emitter-Base Voltage	12	V
I _C	Collector Current - Continuous	800	mA
T _{J,} T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Ma	Unit	
	Farameter	MMBTA28 ⁽³⁾	PZTA28 ⁽⁴⁾	John
P _D	Total Device Dissipation	350	1000	mW
	Derate Above 25°C	2.8	8.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	357	125	°C/W

Notes:

- 3. Device mounted on FR-4 PCB 36mm × 18mm × 1.5mm; mounting pad for the collector lead minimum 6cm².
- 4. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics(5)

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_C = 100 \mu A, V_{BE} = 0$	80		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	80		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	12		V
I _{CBO}	Collector Cut-Off Current	$V_{CB} = 60 \text{ V}, I_{E} = 0$		100	nA
I _{CES}	Collector Cut-Off Current	V _{CE} = 60 V, V _{BE} = 0		500	nA
I _{EBO}	Emitter Cut-Off Current	V _{EB} = 10 V, I _C = 0		100	nA
h	DC Current Gain	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10000		
h _{FE}		$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10000		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 0.01 \text{ mA}$		1.2	V
		I _C = 100 mA, I _B = 0.1 mA		1.5	
V _{BE(on)}	Base-Emitter On Voltage	$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$		2.0	V
f _T	Current Gain - Bandwidth Product	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 100 MHz	125		MHz
C _{obo}	Output Capacitance	V _{CB} = 1.0 V, I _E = 0, f = 1.0 MHz		8.0	pF

Note:

5. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2%.

Typical Performance Characteristics

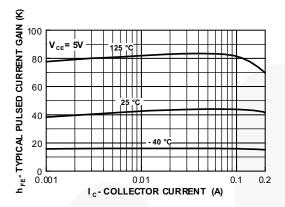


Figure 3. Typical Pulsed Current Gain vs. Collector Current

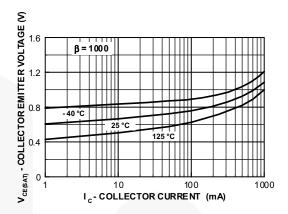


Figure 4. Collector-Emitter Saturation Voltage vs.
Collector Current

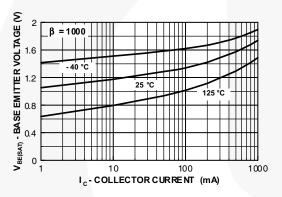


Figure 5. Base-Emitter Saturation Voltage vs.
Collector Current

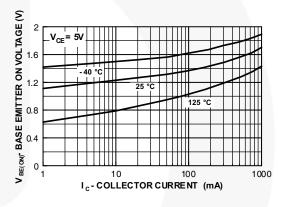


Figure 6. Base-Emitter On Voltage vs.
Collector Current

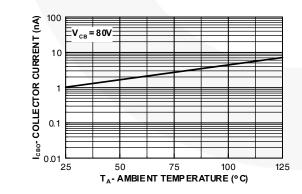


Figure 7. Collector Cut-Off Current vs.
Ambient Temperature

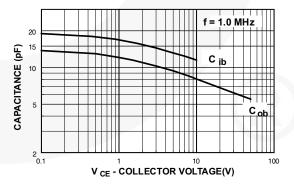
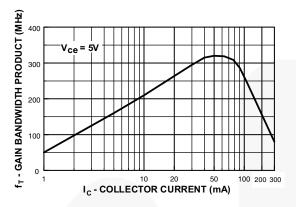


Figure 8. Input and Output Capacitance vs. Reverse Voltage

Typical Performance Characteristics (Continued)



E 114.2 114.2 113.6 113.6 113.4 113.2 113.0 113.8 113.0 113.8 113.0 113

Figure 9. Gain Bandwidth Product vs. Collector Current

Figure 10. Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base

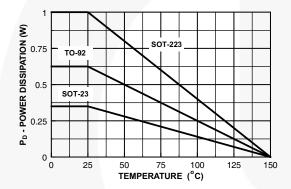
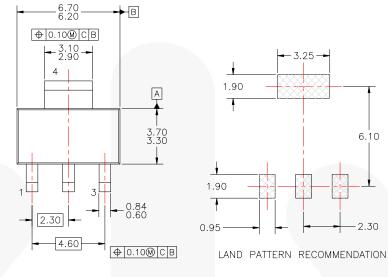


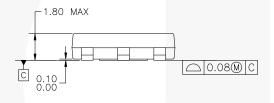
Figure 11. Power Dissipation vs.
Ambient Temperature

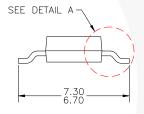
Physical Dimensions 0.95 2.92±0.12-A 3 В 1.40 1.40±0.12 2.20 2 (0.29)--1.00◆ 0.20M A B 0.95 -1.90 -1.90 LAND PATTERN RECOMMENDATION SEE DETAIL A--1.12 MAX 0.10 (0.94)○ 0.10 C C 2.51 ± 0.20 GAGE PLANE NOTES: UNLESS OTHERWISE SPECIFIED 0.20 NO JEDEC REFERENCE AS OF AUGUST 2003 ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS. DIMENSIONING AND TOLERANCING PER ASME Y14.5M — 1994. 0.43 0.33 SEATING PLANE (0.56)DETAIL A SCALE: 50:1 MA03BREVB

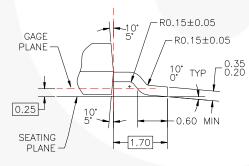
Figure 12. MOLDED PACKAGE, SUPERSOT, 3-LEAD

Physical Dimensions (Continued)









DETAIL A

NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING BASED ON JEDEC
 REGISTRATION TO-261, VARIATION AA.
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 LANDPATTERN NAME:
 S0T230P700X180-4BN
 DRAWING FILENAME: MKT-MA04AREV2

- E)

Figure 13. MOLDED PACKAGING, SOT-223, 4-LEAD





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